## Abstract

An adhesive sheet composed of a blend of a synthetic rubber S1 and a thermoplastic 2,

- a) the blend being microphase-separated,
- b) the blend possessing at least two softening temperatures, at least one softening temperature being greater than 65°C and less than 125°C,
  - c) a G' at 23°C, as measured by test method A, of greater than 10<sup>7</sup> Pas,
  - d) a G" at 23°C, as measured by test method A, of greater than 10<sup>6</sup> Pas,
  - e) and a crossover, as measured by test method A, of less than 125°C
- 10 for bonding electrical modules in chip cards.